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Details

Product Status	Obsolete
Core Processor	HCS12
Core Size	16-Bit
Speed	25MHz
Connectivity	CANbus, EBI/EMI, I ² C, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	91
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.35V ~ 5.5V
Data Converters	A/D 16x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	112-LQFP
Supplier Device Package	112-LQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc9s12kg128mpve

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0x001C–0x001D MMC Map 3 of 4 (HCS12 Module Mapping Control, Device Guide)

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x001C	MEMSIZ0	R	reg_sw0	0	eep_sw1	eep_sw0	0	ram_sw2	ram_sw1	ram_sw0
		W								
0x001D	MEMSIZ1	R	rom_sw1	rom_sw0	0	0	0	0	pag_sw1	pag_sw0
		W								

0x001E–0x001E MEBI Map 2 of 3 (HCS12 Multiplexed External Bus Interface)

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x001E	INTCR	R	IRQE	IRQEN	0	0	0	0	0	0
		W								

0x001F–0x001F INT Map 2 of 2 (HCS12 Interrupt)

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x001F	HPRIO	R	PSEL7	PSEL6	PSEL5	PSEL4	PSEL3	PSEL2	PSEL1	0
		W								

0x0020–0x002F DBG Map 1 of 1 (HCS12 Debug)

Address	Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
0x0020	DBGC1	R	DBGEN	ARM	TRGSEL	BEGIN	DBGBRK	0	CAPMOD			
	—	W										
0x0021	DBGSC	R	AF	BF	CF	0	TRG					
	—	W										
0x0022	DBGTBH	R	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8		
	—	W										
0x0023	DBGTBL	R	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
	—	W										
0x0024	DBGCNT	R	TBF	0	CNT							
	—	W										
0x0025	DBGCCX	R	PAGSEL		EXTCMP							
	—	W										
0x0026	DBGCCH	R	Bit 15	14	13	12	11	10	9	Bit 8		
	—	W										
0x0027	DBGCCL	R	Bit 7	6	5	4	3	2	1	Bit 0		
	—	W										
0x0028	DBGC2	R	BKABEN	FULL	BDM	TAGAB	BKCEN	TAGC	RWCEN	RWC		
	BKPCT0	W										
0x0029	DBGC3	R	BKAMBH	BKAMBL	BKBMBH	BKBMBL	RWAEN	RWA	RWBEN	RWB		
	BKPCT1	W										
0x002A	DBGCAx	R	PAGSEL		EXTCMP							
	BKP0x	W										
0x002B	DBGCAH	R	Bit 15	14	13	12	11	10	9	Bit 8		
	BKP0H	W										

Table 2-3. Detailed Flash Memory Map Summary

MCU Address Range	PPAGE	Protectable Lower Range	Protectable Higher Range	Block Relative Address ¹
0x4000-0x7FFF	Unpaged (0x3E)	0x4000-0x43FF 0x4000-0x47FF 0x4000-0x4FFF 0x4000-0x5FFF	N.A.	0x18000-0x1BFFF
0x8000-0xBFFF	0x38	N.A.	N.A.	0x00000-0x03FFF
	0x39	N.A.	N.A.	0x04000-0x07FFF
	0x3A	N.A.	N.A.	0x08000-0x0BFFF
	0x3B	N.A.	N.A.	0x0C000-0x0FFFF
	0x3C	N.A.	N.A.	0x10000-0x13FFF
	0x3D	N.A.	N.A.	0x14000-0x17FFF
	0x3E	0x8000-0x83FF 0x8000-0x87FF 0x8000-0x8FFF 0x8000-0x9FFF	N.A.	0x18000-0x1BFFF
	0x3F	N.A.	0xB800-0xBFFF 0xB000-0xBFFF 0xA000-0xBFFF 0x8000-0xBFFF	0x1C000-0x1FFFF
0xC000-0xFFFF	Unpaged (0x3F)	N.A.	0xF800-0xFFFF 0xF000-0xFFFF 0xE000-0xFFFF 0xC000-0xFFFF	0x1C000-0x1FFFF

¹ Block Relative Address for 128 Kbyte Flash block consists of 17 address bits.

The Flash module also contains a set of 16 control and status registers located in address space module base + 0x0000 to module base + 0x000F. A summary of these registers is given in [Table 2-4](#) while their accessibility in normal and special modes is detailed in [Section 2.3.2, “Register Descriptions”](#).

Table 2-4. Flash Register Map

MODULE BASE +	Use	Normal Mode Access
0x0000	Flash Clock Divider Register (FCLKDIV)	R/W
0x0001	Flash Security Register (FSEC)	R
0x0002	Flash Test Mode Register (FTSTMOD)	R/W
0x0003	Flash Configuration Register (FCNFG)	R/W
0x0004	Flash Protection Register (FPROT)	R/W

Module Base + 0x0002

	7	6	5	4	3	2	1	0
R	0	0	0	0	0	0	0	0
W								
Reset	0	0	0	0	0	0	0	0


 = Unimplemented or Reserved

Figure 3-6. RESERVED2

All bits read 0 and are not writable.

3.3.2.4 EEPROM Configuration Register (ECNFG)

The ECNFG register enables the EEPROM interrupts.

Module Base + 0x0003

	7	6	5	4	3	2	1	0
R	CBEIE	CCIE	0	0	0	0	0	0
W								
Reset	0	0	0	0	0	0	0	0

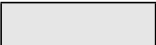
 = Unimplemented or Reserved

Figure 3-7. EEPROM Configuration Register (ECNFG)

CBEIE and CCIE bits are readable and writable while bits 5-0 read 0 and are not writable.

Table 3-4. ECNFG Field Descriptions

Field	Description
7 CBEIE	Command Buffer Empty Interrupt Enable — The CBEIE bit enables the interrupts in case of an empty command buffer in the EEPROM. 0 Command buffer empty interrupts disabled. 1 An interrupt will be requested whenever the CBEIF flag is set (see Section 3.3.2.6, “EEPROM Status Register (ESTAT)”).
6 CCIE	Command Complete Interrupt Enable — The CCIE bit enables the interrupts in case of all commands being completed in the EEPROM. 0 Command complete interrupts disabled. 1 An interrupt will be requested whenever the CCIF flag is set (see Section 3.3.2.6, “EEPROM Status Register (ESTAT)”).

3.3.2.5 EEPROM Protection Register (EPROT)

The EPROT register defines which EEPROM sectors are protected against program or erase.

4.4.3 Data Direction Register

The Data Direction Register defines whether the pin is used as an input or an output. A Data Direction Register bit set to 0 configures the pin as an input. A Data Direction Register bit set to 1 configures the pin as an output. If a peripheral module controls the pin the contents of the data direction register is ignored (Figure 4-47).

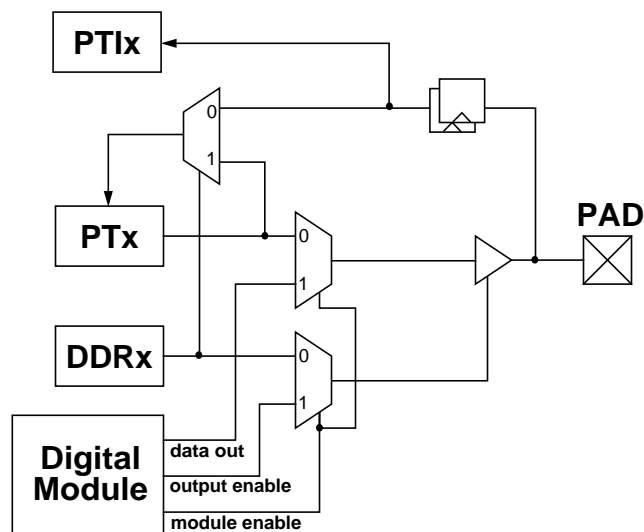


Figure 4-47. Illustration of I/O Pin Functionality

Figure 4-48 shows the state of digital inputs and outputs when an analog module drives the port. When the analog module is enabled all associated digital output ports are disabled and all associated digital input ports read “1”.

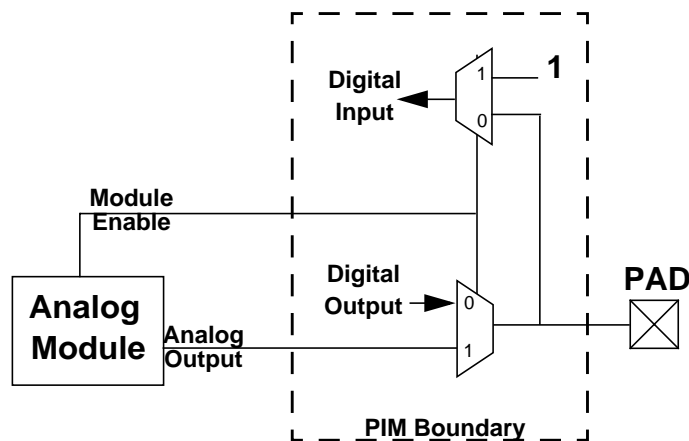


Figure 4-48. Digital Ports and Analog Module

4.4.4 Reduced Drive Register

If the port is used as an output the Reduced Drive Register allows the configuration of the drive strength.

Table 5-12. Outcome of Clock Loss in Pseudo-Stop Mode (continued)

CME	SCME	SCMIE	CRG Actions
1	1	1	<p>Clock failure --></p> <ul style="list-style-type: none"> – VREG enabled, – PLL enabled, – SCM activated, – Start Clock Quality Check, – SCMIF set. <p>SCMIF generates Self-Clock Mode wakeup interrupt.</p> <ul style="list-style-type: none"> – Exit Pseudo-Stop Mode in SCM using PLL clock (f_{SCM}) as system clock, – Continue to perform a additional Clock Quality Checks until OSCCLK is o.k. again.

5.4.10.2 Wake-up from Full Stop (PSTP=0)

The MCU requires an external interrupt or an external reset in order to wake-up from stop mode.

If the MCU gets an external reset during full stop mode active, the CRG asynchronously restores all configuration bits in the register space to its default settings and will perform a maximum of 50 clock *check_windows* (see [Section 5.4.4, “Clock Quality Checker”](#)). After completing the clock quality check the CRG starts the reset generator. After completing the reset sequence processing begins by fetching the normal reset vector. Full stop mode is exited and the MCU is in run mode again.

If the MCU is woken-up by an interrupt, the CRG will also perform a maximum of 50 clock *check_windows* (see [Section 5.4.4, “Clock Quality Checker”](#)). If the clock quality check is successful, the CRG will release all system and core clocks and will continue with normal operation. If all clock checks within the timeout-window are failing, the CRG will switch to self-clock mode or generate a clock monitor reset (CMRESET) depending on the setting of the SCME bit.

Because the PLL has been powered-down during stop mode the PLLSEL bit is cleared and the MCU runs on OSCCLK after leaving stop mode. The software must manually set the PLLSEL bit again, in order to switch system and core clocks to the PLLCLK.

NOTE

In full stop mode, the clock monitor is disabled and any loss of clock will not be detected.

5.5 Resets

This section describes how to reset the CRGV4 and how the CRGV4 itself controls the reset of the MCU. It explains all special reset requirements. Because the reset generator for the MCU is part of the CRG, this section also describes all automatic actions that occur during or as a result of individual reset conditions. The reset values of registers and signals are provided in [Section 5.3, “Memory Map and Register](#)

writes (0x0055 or 0x00AA) to the ARMCOP register must occur in the last 25% of the selected time-out period. A premature write the CRG will immediately generate a reset.

As soon as the reset sequence is completed the reset generator checks the reset condition. If no clock monitor failure is indicated and the latched state of the COP timeout is true, processing begins by fetching the COP vector.

5.5.3 Power-On Reset, Low Voltage Reset

The on-chip voltage regulator detects when V_{DD} to the MCU has reached a certain level and asserts power-on reset or low voltage reset or both. As soon as a power-on reset or low voltage reset is triggered the CRG performs a quality check on the incoming clock signal. As soon as clock quality check indicates a valid oscillator clock signal the reset sequence starts using the oscillator clock. If after 50 check windows the clock quality check indicated a non-valid oscillator clock the reset sequence starts using self-clock mode.

Figure 5-26 and Figure 5-27 show the power-up sequence for cases when the $\overline{\text{RESET}}$ pin is tied to V_{DD} and when the $\overline{\text{RESET}}$ pin is held low.

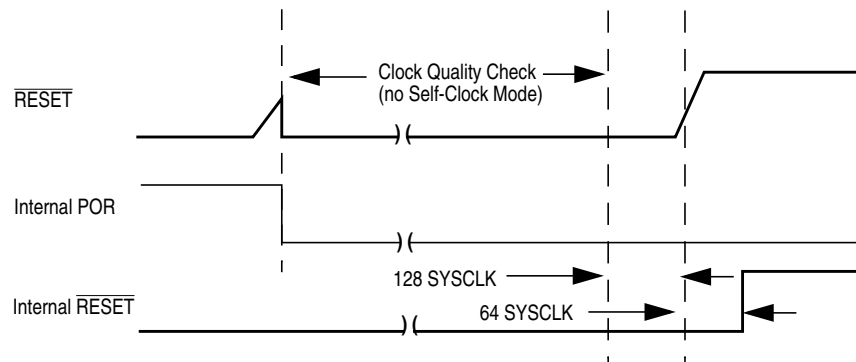


Figure 5-26. $\overline{\text{RESET}}$ Pin Tied to V_{DD} (by a Pull-Up Resistor)

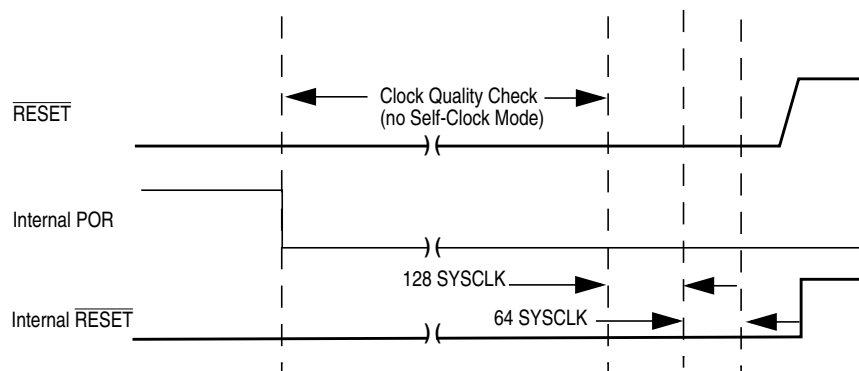


Figure 5-27. $\overline{\text{RESET}}$ Pin Held Low Externally

Table 7-6. ATDCTL2 Field Descriptions

Field	Description
7 ADPU	ATD Power Down — This bit provides on/off control over the ATD10B16C block allowing reduced MCU power consumption. Because analog electronic is turned off when powered down, the ATD requires a recovery time period after ADPU bit is enabled. 0 Power down ATD 1 Normal ATD functionality
6 AFFC	ATD Fast Flag Clear All 0 ATD flag clearing operates normally (read the status register ATDSTAT1 before reading the result register to clear the associate CCF flag). 1 Changes all ATD conversion complete flags to a fast clear sequence. Any access to a result register will cause the associate CCF flag to clear automatically.
5 AWAI	ATD Power Down in Wait Mode — When entering Wait Mode this bit provides on/off control over the ATD10B16C block allowing reduced MCU power. Because analog electronic is turned off when powered down, the ATD requires a recovery time period after exit from Wait mode. 0 ATD continues to run in Wait mode 1 Halt conversion and power down ATD during Wait mode After exiting Wait mode with an interrupt conversion will resume. But due to the recovery time the result of this conversion should be ignored.
4 ETRIGLE	External Trigger Level/Edge Control — This bit controls the sensitivity of the external trigger signal. See Table 7-7 for details.
3 ETRIGP	External Trigger Polarity — This bit controls the polarity of the external trigger signal. See Table 7-7 for details.
2 ETRIGE	External Trigger Mode Enable — This bit enables the external trigger on one of the AD channels or the ETRIG input as described in Table 7-5 . If external trigger source is one of the AD channels, the digital input buffer of this channel is enabled. The external trigger allows to synchronize the start of conversion with external events. 0 Disable external trigger 1 Enable external trigger Note: If using one of the ATD channel as external trigger (ETRIGSEL = 0) the conversion results for this channel have no meaning while external trigger mode is enabled.
1 ASCIE	ATD Sequence Complete Interrupt Enable 0 ATD Sequence Complete interrupt requests are disabled. 1 ATD Interrupt will be requested whenever ASCIF = 1 is set.
0 ASCIF	ATD Sequence Complete Interrupt Flag — If ASCIE = 1 the ASCIF flag equals the SCF flag (see Section 7.3.2.7, “ATD Status Register 0 (ATDSTAT0)”), else ASCIF reads zero. Writes have no effect. 0 No ATD interrupt occurred 1 ATD sequence complete interrupt pending

Table 7-7. External Trigger Configurations

ETRIGLE	ETRIGP	External Trigger Sensitivity
0	0	Falling Edge
0	1	Ring Edge
1	0	Low Level
1	1	High Level

Table 10-3. Loop Functions

LOOPS	RSRC	Function
0	x	Normal operation
1	0	Loop mode with Rx input internally connected to Tx output
1	1	Single-wire mode with Rx input connected to TXD

10.3.2.3 SCI Control Register 2 (SCICR2)

Module Base + 0x_0003

	7	6	5	4	3	2	1	0
R	TIE	TCIE	RIE	ILIE	TE	RE	RWU	SBK
W								
Reset	0	0	0	0	0	0	0	0

Figure 10-5. SCI Control Register 2 (SCICR2)

Read: Anytime

Write: Anytime

Table 10-4. SCICR2 Field Descriptions

Field	Description
7 TIE	Transmitter Interrupt Enable Bit — TIE enables the transmit data register empty flag, TDRE, to generate interrupt requests. 0 TDRE interrupt requests disabled 1 TDRE interrupt requests enabled
6 TCIE	Transmission Complete Interrupt Enable Bit — TCIE enables the transmission complete flag, TC, to generate interrupt requests. 0 TC interrupt requests disabled 1 TC interrupt requests enabled
5 RIE	Receiver Full Interrupt Enable Bit — RIE enables the receive data register full flag, RDRF, or the overrun flag, OR, to generate interrupt requests. 0 RDRF and OR interrupt requests disabled 1 RDRF and OR interrupt requests enabled
4 ILIE	Idle Line Interrupt Enable Bit — ILIE enables the idle line flag, IDLE, to generate interrupt requests. 0 IDLE interrupt requests disabled 1 IDLE interrupt requests enabled
3 TE	Transmitter Enable Bit — TE enables the SCI transmitter and configures the TXD pin as being controlled by the SCI. The TE bit can be used to queue an idle preamble. 0 Transmitter disabled 1 Transmitter enabled
2 RE	Receiver Enable Bit — RE enables the SCI receiver. 0 Receiver disabled 1 Receiver enabled

10.4.3 Transmitter

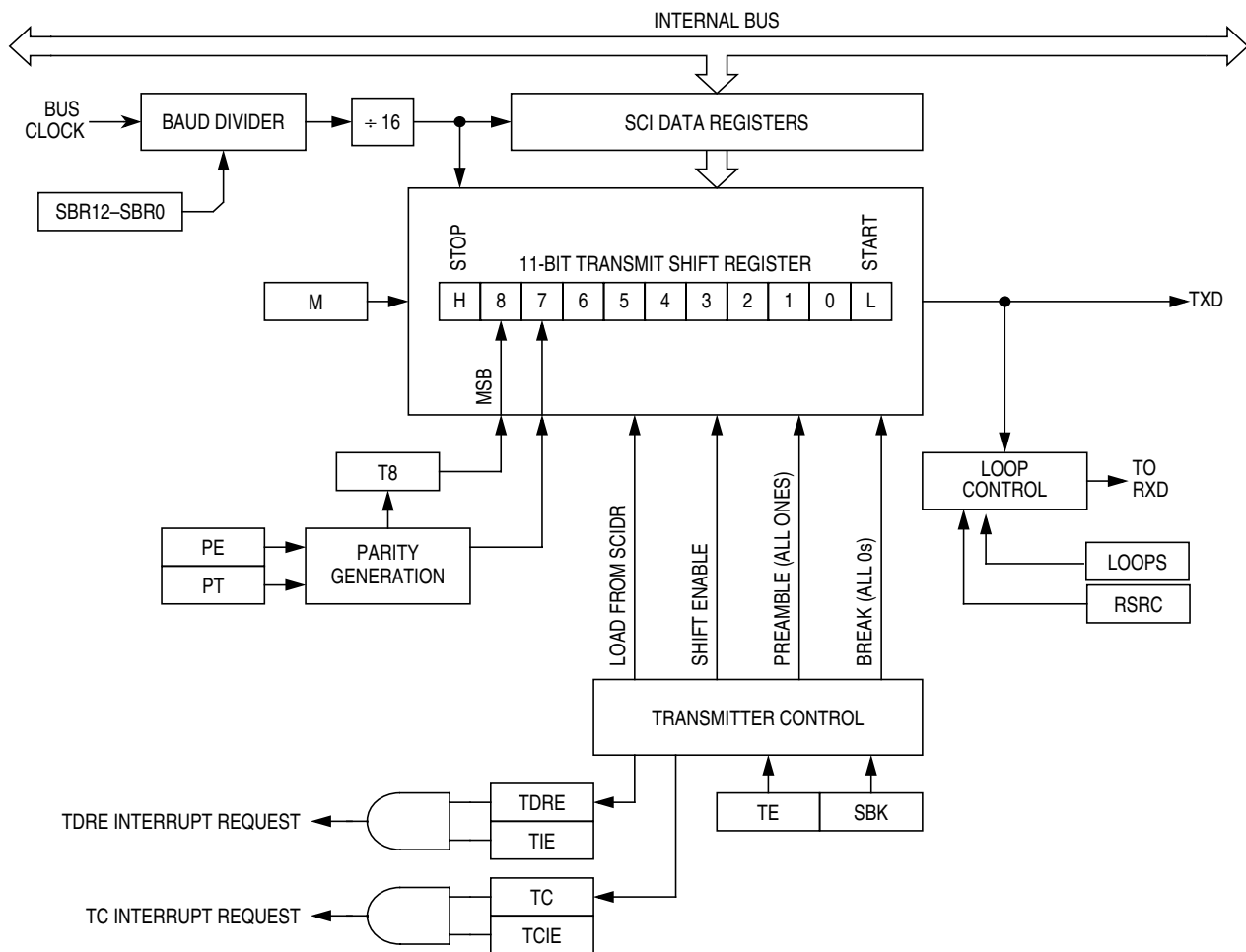


Figure 10-11. Transmitter Block Diagram

10.4.3.1 Transmitter Character Length

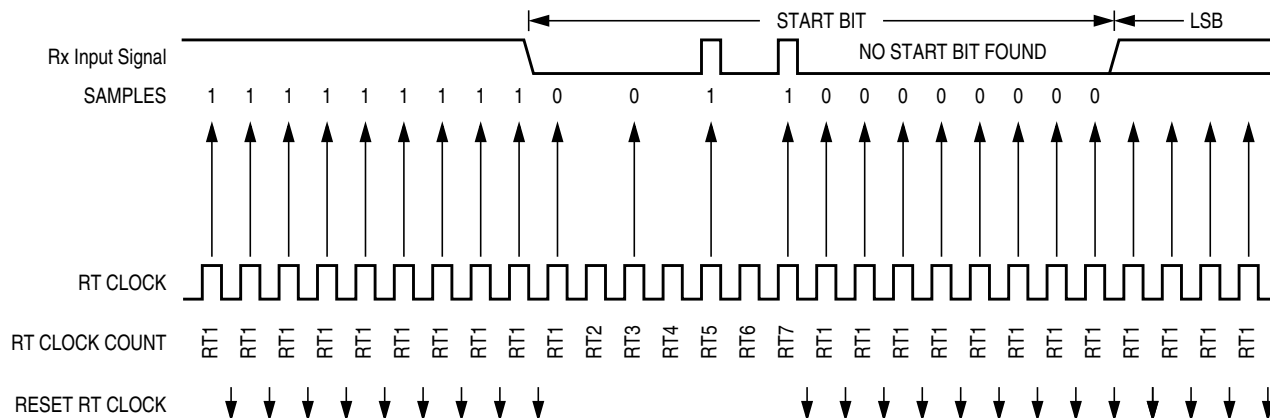
The SCI transmitter can accommodate either 8-bit or 9-bit data characters. The state of the M bit in SCI control register 1 (SCICR1) determines the length of data characters. When transmitting 9-bit data, bit T8 in SCI data register high (SCIDRH) is the ninth bit (bit 8).

10.4.3.2 Character Transmission

To transmit data, the MCU writes the data bits to the SCI data registers (SCIDRH/SCIDRL), which in turn are transferred to the transmitter shift register. The transmit shift register then shifts a frame out through the **Tx output** signal, after it has prefaced them with a start bit and appended them with a stop bit. The SCI data registers (SCIDRH and SCIDRL) are the write-only buffers between the internal data bus and the transmit shift register.

The SCI also sets a flag, the transmit data register empty flag (TDRE), every time it transfers data from the buffer (SCIDRH/L) to the transmitter shift register. The transmit driver routine may respond to this flag

Figure 10-18 shows a burst of noise near the beginning of the start bit that resets the RT clock. The sample after the reset is low but is not preceded by three high samples that would qualify as a falling edge. Depending on the timing of the start bit search and on the data, the frame may be missed entirely or it may set the framing error flag.



In [Figure 10-19](#), a noise burst makes the majority of data samples RT8, RT9, and RT10 high. This sets the noise flag but does not reset the RT clock. In start bits only, the RT8, RT9, and RT10 data samples are ignored.

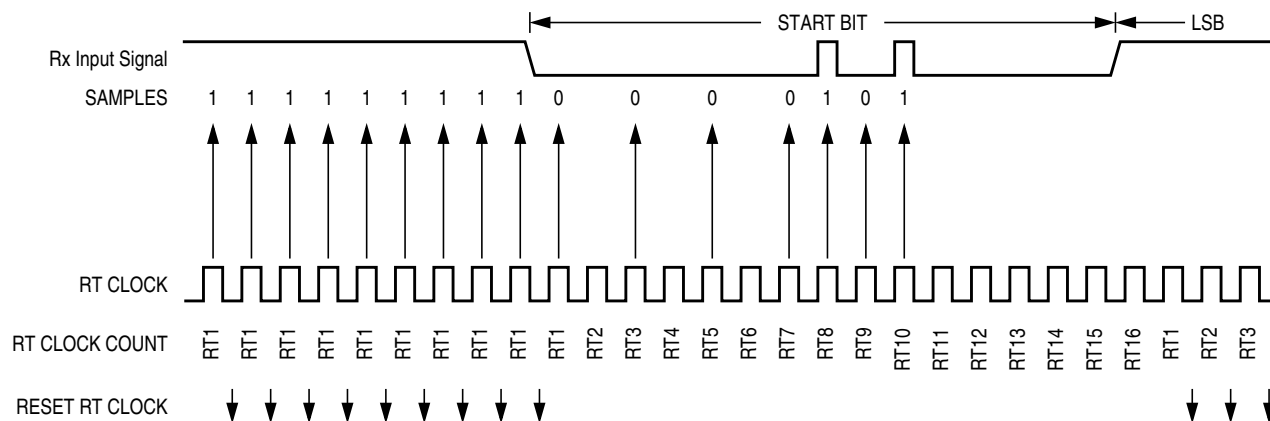


Table 11-2. SPICR1 Field Descriptions

Field	Description
7 SPIE	SPI Interrupt Enable Bit — This bit enables SPI interrupt requests, if SPIF or MODF status flag is set. 0 SPI interrupts disabled. 1 SPI interrupts enabled.
6 SPE	SPI System Enable Bit — This bit enables the SPI system and dedicates the SPI port pins to SPI system functions. If SPE is cleared, SPI is disabled and forced into idle state, status bits in SPISR register are reset. 0 SPI disabled (lower power consumption). 1 SPI enabled, port pins are dedicated to SPI functions.
5 SPTIE	SPI Transmit Interrupt Enable — This bit enables SPI interrupt requests, if SPTEF flag is set. 0 SPTEF interrupt disabled. 1 SPTEF interrupt enabled.
4 MSTR	SPI Master/Slave Mode Select Bit — This bit selects, if the SPI operates in master or slave mode. Switching the SPI from master to slave or vice versa forces the SPI system into idle state. 0 SPI is in slave mode 1 SPI is in master mode
3 CPOL	SPI Clock Polarity Bit — This bit selects an inverted or non-inverted SPI clock. To transmit data between SPI modules, the SPI modules must have identical CPOL values. In master mode, a change of this bit will abort a transmission in progress and force the SPI system into idle state. 0 Active-high clocks selected. In idle state SCK is low. 1 Active-low clocks selected. In idle state SCK is high.
2 CPHA	SPI Clock Phase Bit — This bit is used to select the SPI clock format. In master mode, a change of this bit will abort a transmission in progress and force the SPI system into idle state. 0 Sampling of data occurs at odd edges (1,3,5,...,15) of the SCK clock 1 Sampling of data occurs at even edges (2,4,6,...,16) of the SCK clock
1 SSOE	Slave Select Output Enable — The \overline{SS} output feature is enabled only in master mode, if MODFEN is set, by asserting the SSOE as shown in Table 11-3. In master mode, a change of this bit will abort a transmission in progress and force the SPI system into idle state.
0 LSBFE	LSB-First Enable — This bit does not affect the position of the MSB and LSB in the data register. Reads and writes of the data register always have the MSB in bit 7. In master mode, a change of this bit will abort a transmission in progress and force the SPI system into idle state. 0 Data is transferred most significant bit first. 1 Data is transferred least significant bit first.

Table 11-3. \overline{SS} Input / Output Selection

MODFEN	SSOE	Master Mode	Slave Mode
0	0	\overline{SS} not used by SPI	\overline{SS} input
0	1	\overline{SS} not used by SPI	\overline{SS} input
1	0	\overline{SS} input with MODF feature	\overline{SS} input
1	1	\overline{SS} is slave select output	\overline{SS} input

11.3.2.4 SPI Status Register (SPISR)

Module Base 0x0003

	7	6	5	4	3	2	1	0
R	SPIF	0	SPTEF	MODF	0	0	0	0
W								
Reset	0	0	1	0	0	0	0	0

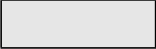
 = Unimplemented or Reserved

Figure 11-6. SPI Status Register (SPISR)

Read: anytime

Write: has no effect

Table 11-8. SPISR Field Descriptions

Field	Description
7 SPIF	SPIF Interrupt Flag — This bit is set after a received data byte has been transferred into the SPI Data Register. This bit is cleared by reading the SPISR register (with SPIF set) followed by a read access to the SPI Data Register. 0 Transfer not yet complete 1 New data copied to SPIDR
5 SPTEF	SPI Transmit Empty Interrupt Flag — If set, this bit indicates that the transmit data register is empty. To clear this bit and place data into the transmit data register, SPISR has to be read with SPTEF = 1, followed by a write to SPIDR. Any write to the SPI Data Register without reading SPTEF = 1, is effectively ignored. 0 SPI Data register not empty 1 SPI Data register empty
4 MODF	Mode Fault Flag — This bit is set if the \overline{SS} input becomes low while the SPI is configured as a master and mode fault detection is enabled, MODFEN bit of SPICR2 register is set. Refer to MODFEN bit description in Section 11.3.2.2, “SPI Control Register 2 (SPICR2)” . The flag is cleared automatically by a read of the SPI Status Register (with MODF set) followed by a write to the SPI Control Register 1. 0 Mode fault has not occurred. 1 Mode fault has occurred.

11.3.2.5 SPI Data Register (SPIDR)

Module Base 0x0005

	7	6	5	4	3	2	1	0
R	Bit 7	6	5	4	3	2	2	Bit 0
W								
Reset	0	0	0	0	0	0	0	0

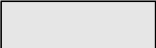
 = Unimplemented or Reserved

Figure 11-7. SPI Data Register (SPIDR)

Read: anytime; normally read only after SPIF is set

11.4.2 Slave Mode

The SPI operates in slave mode when the MSTR bit in SPI Control Register1 is clear.

- SCK Clock

In slave mode, SCK is the SPI clock input from the master.

- MISO and MOSI Pins

In slave mode, the function of the serial data output pin (MISO) and serial data input pin (MOSI) is determined by the SPC0 bit and BIDIROE bit in SPI Control Register 2.

- \overline{SS} Pin

The \overline{SS} pin is the slave select input. Before a data transmission occurs, the \overline{SS} pin of the slave SPI must be low. \overline{SS} must remain low until the transmission is complete. If \overline{SS} goes high, the SPI is forced into idle state.

The \overline{SS} input also controls the serial data output pin, if \overline{SS} is high (not selected), the serial data output pin is high impedance, and, if \overline{SS} is low the first bit in the SPI Data Register is driven out of the serial data output pin. Also, if the slave is not selected (\overline{SS} is high), then the SCK input is ignored and no internal shifting of the SPI shift register takes place.

Although the SPI is capable of duplex operation, some SPI peripherals are capable of only receiving SPI data in a slave mode. For these simpler devices, there is no serial data out pin.

NOTE

When peripherals with duplex capability are used, take care not to simultaneously enable two receivers whose serial outputs drive the same system slave's serial data output line.

As long as no more than one slave device drives the system slave's serial data output line, it is possible for several slaves to receive the same transmission from a master, although the master would not receive return information from all of the receiving slaves.

If the CPHA bit in SPI Control Register 1 is clear, odd numbered edges on the SCK input cause the data at the serial data input pin to be latched. Even numbered edges cause the value previously latched from the serial data input pin to shift into the LSB or MSB of the SPI shift register, depending on the LSBFE bit.

If the CPHA bit is set, even numbered edges on the SCK input cause the data at the serial data input pin to be latched. Odd numbered edges cause the value previously latched from the serial data input pin to shift into the LSB or MSB of the SPI shift register, depending on the LSBFE bit.

When CPHA is set, the first edge is used to get the first data bit onto the serial data output pin. When CPHA is clear and the \overline{SS} input is low (slave selected), the first bit of the SPI data is driven out of the serial data output pin. After the eighth shift, the transfer is considered complete and the received data is transferred into the SPI Data Register. To indicate transfer is complete, the SPIF flag in the SPI Status Register is set.

NOTE

A change of the bits CPOL, CPHA, SSOE, LSBFE, MODFEN, SPC0 and BIDIROE with SPC0 set in slave mode will corrupt a transmission in progress and has to be avoided.

Module Base + 0x0002

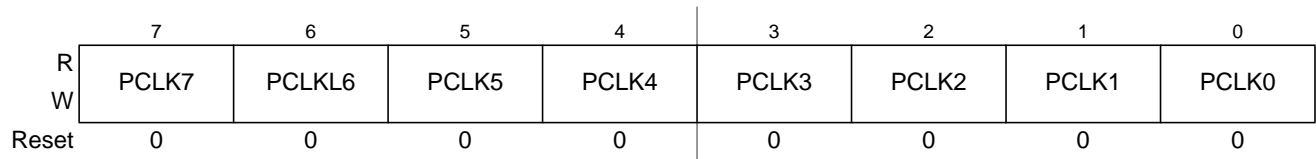


Figure 12-5. PWM Clock Select Register (PWMCLK)

Read: Anytime

Write: Anytime

NOTE

Register bits PCLK0 to PCLK7 can be written anytime. If a clock select is changed while a PWM signal is being generated, a truncated or stretched pulse can occur during the transition.

Table 12-3. PWMCLK Field Descriptions

Field	Description
7 PCLK7	Pulse Width Channel 7 Clock Select 0 Clock B is the clock source for PWM channel 7. 1 Clock SB is the clock source for PWM channel 7.
6 PCLK6	Pulse Width Channel 6 Clock Select 0 Clock B is the clock source for PWM channel 6. 1 Clock SB is the clock source for PWM channel 6.
5 PCLK5	Pulse Width Channel 5 Clock Select 0 Clock A is the clock source for PWM channel 5. 1 Clock SA is the clock source for PWM channel 5.
4 PCLK4	Pulse Width Channel 4 Clock Select 0 Clock A is the clock source for PWM channel 4. 1 Clock SA is the clock source for PWM channel 4.
3 PCLK3	Pulse Width Channel 3 Clock Select 0 Clock B is the clock source for PWM channel 3. 1 Clock SB is the clock source for PWM channel 3.
2 PCLK2	Pulse Width Channel 2 Clock Select 0 Clock B is the clock source for PWM channel 2. 1 Clock SB is the clock source for PWM channel 2.
1 PCLK1	Pulse Width Channel 1 Clock Select 0 Clock A is the clock source for PWM channel 1. 1 Clock SA is the clock source for PWM channel 1.
0 PCLK0	Pulse Width Channel 0 Clock Select 0 Clock A is the clock source for PWM channel 0. 1 Clock SA is the clock source for PWM channel 0.

12.3.2.4 PWM Prescale Clock Select Register (PWMPRCLK)

This register selects the prescale clock source for clocks A and B independently.

14.2.3 V_{DD} , V_{SS} — Regulator Output1 (Core Logic)

Signals V_{DD}/V_{SS} are the primary outputs of VREG3V3V2 that provide the power supply for the core logic. These signals are connected to device pins to allow external decoupling capacitors (100 nF...220 nF, X7R ceramic).

In shutdown mode an external supply at V_{DD}/V_{SS} can replace the voltage regulator.

14.2.4 V_{DDPLL} , V_{SSPLL} — Regulator Output2 (PLL)

Signals V_{DDPLL}/V_{SSPLL} are the secondary outputs of VREG3V3V2 that provide the power supply for the PLL and oscillator. These signals are connected to device pins to allow external decoupling capacitors (100 nF...220 nF, X7R ceramic).

In shutdown mode an external supply at V_{DDPLL}/V_{SSPLL} can replace the voltage regulator.

14.2.5 V_{REGEN} — Optional Regulator Enable

This optional signal is used to shutdown VREG3V3V2. In that case V_{DD}/V_{SS} and V_{DDPLL}/V_{SSPLL} must be provided externally. shutdown mode is entered with V_{REGEN} being low. If V_{REGEN} is high, the VREG3V3V2 is either in full-performance mode or in reduced-power mode.

For the connectivity of V_{REGEN} see device overview chapter.

NOTE

Switching from FPM or RPM to shutdown of VREG3V3V2 and vice versa is not supported while the MCU is powered.

14.3 Memory Map and Register Definition

This subsection provides a detailed description of all registers accessible in VREG3V3V2.

14.3.1 Module Memory Map

Figure 14-2 provides an overview of all used registers.

Table 14-2. VREG3V3V2 Memory Map

Address Offset	Use	Access
0x0000	VREG3V3V2 Control Register (VREGCTRL)	R/W

15.3.2.2 BDM CCR Holding Register (BDMCCR)

0xFF06

	7	6	5	4	3	2	1	0
R	CCR7	CCR6	CCR5	CCR4	CCR3	CCR2	CCR1	CCR0
W								
Reset	0	0	0	0	0	0	0	0

Figure 15-4. BDM CCR Holding Register (BDMCCR)

Read: All modes

Write: All modes

NOTE

When BDM is made active, the CPU stores the value of the CCR register in the BDMCCR register. However, out of special single-chip reset, the BDMCCR is set to 0xD8 and not 0xD0 which is the reset value of the CCR register.

When entering background debug mode, the BDM CCR holding register is used to save the contents of the condition code register of the user's program. It is also used for temporary storage in the standard BDM firmware mode. The BDM CCR holding register can be written to modify the CCR value.

15.3.2.3 BDM Internal Register Position Register (BDMINR)

0xFF07

	7	6	5	4	3	2	1	0
R	0	REG14	REG13	REG12	REG11	0	0	0
W								
Reset	0	0	0	0	0	0	0	0


 = Unimplemented or Reserved

Figure 15-5. BDM Internal Register Position (BDMINR)

Read: All modes

Write: Never

Table 15-4. BDMINR Field Descriptions

Field	Description
6:3 REG[14:11]	Internal Register Map Position — These four bits show the state of the upper five bits of the base address for the system's relocatable register block. BDMINR is a shadow of the INITRG register which maps the register block to any 2K byte space within the first 32K bytes of the 64K byte address space.

16.3.2.2 Debug Status and Control Register (DBGSC)

Module Base + 0x0021

Starting address location affected by INITRG register setting.

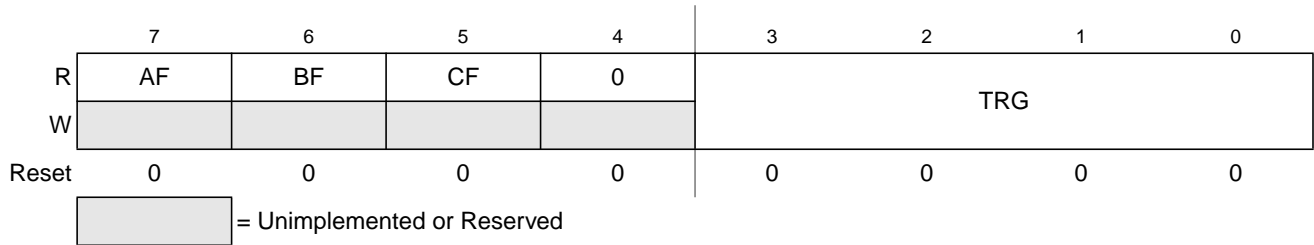


Figure 16-5. Debug Status and Control Register (DBGSC)

Table 16-5. DBGSC Field Descriptions

Field	Description
7 AF	Trigger A Match Flag — The AF bit indicates if trigger A match condition was met since arming. This bit is cleared when ARM in DBGSC1 is written to a 1 or on any write to this register. 0 Trigger A did not match 1 Trigger A match
6 BF	Trigger B Match Flag — The BF bit indicates if trigger B match condition was met since arming. This bit is cleared when ARM in DBGSC1 is written to a 1 or on any write to this register. 0 Trigger B did not match 1 Trigger B match
5 CF	Comparator C Match Flag — The CF bit indicates if comparator C match condition was met since arming. This bit is cleared when ARM in DBGSC1 is written to a 1 or on any write to this register. 0 Comparator C did not match 1 Comparator C match
3:0 TRG	Trigger Mode Bits — The TRG bits select the trigger mode of the DBG module as shown Table 16-6 . See Section 16.4.2.5, “Trigger Modes,” for more detail.

Table 16-6. Trigger Mode Encoding

TRG Value	Meaning
0000	A only
0001	A or B
0010	A then B
0011	Event only B
0100	A then event only B
0101	A and B (full mode)
0110	A and Not B (full mode)
0111	Inside range
1000	Outside range
1001 ↓ 1111	Reserved (Defaults to A only)

This register is not in the on-chip memory map in expanded and special peripheral modes. Therefore, these accesses will be echoed externally.

NOTE

These bits have no effect when the associated pin(s) are outputs. (The pull resistors are inactive.)

Table 18-9. PUCR Field Descriptions

Field	Description
7 PUPKE	Pull resistors Port K Enable 0 Port K pull resistors are disabled. 1 Enable pull resistors for port K input pins.
4 PUPEE	Pull resistors Port E Enable 0 Port E pull resistors on bits 7, 4:0 are disabled. 1 Enable pull resistors for port E input pins bits 7, 4:0. Note: Pins 5 and 6 of port E have pull resistors which are only enabled during reset. This bit has no effect on these pins.
1 PUPBE	Pull resistors Port B Enable 0 Port B pull resistors are disabled. 1 Enable pull resistors for all port B input pins.
0 PUPAE	Pull resistors Port A Enable 0 Port A pull resistors are disabled. 1 Enable pull resistors for all port A input pins.

18.3.2.11 Reduced Drive Register (RDRIV)

Module Base + 0x000D

Starting address location affected by INITRG register setting.

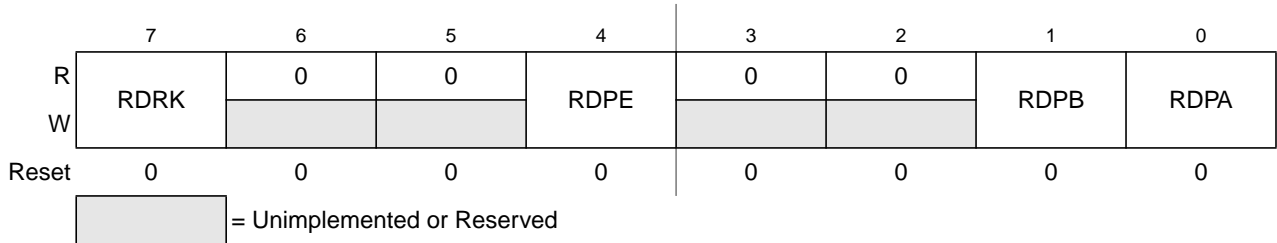


Figure 18-15. Reduced Drive Register (RDRIV)

Read: Anytime (provided this register is in the map)

Write: Anytime (provided this register is in the map)

This register is used to select reduced drive for the pins associated with the core ports. This gives reduced power consumption and reduced RFI with a slight increase in transition time (depending on loading). This feature would be used on ports which have a light loading. The reduced drive function is independent of which function is being used on a particular port.

This register is not in the on-chip memory map in expanded and special peripheral modes. Therefore, these accesses will be echoed externally.

A.4 Output Loads

A.4.1 Resistive Loads

The on-chip voltage regulator is intended to supply the internal logic and oscillator circuits allows no external DC loads.

A.4.2 Capacitive Loads

The capacitive loads are specified in [Table A-10](#). Ceramic capacitors with X7R dielectricum are required.

Table A-10. Voltage Regulator — Capacitive Loads

Num	Characteristic	Symbol	Min	Typical	Max	Unit
1	VDD external capacitive load	C_{DDext}	200	440	12000	nF
2	VDDPLL external capacitive load	$C_{DDPLLext}$	90	220	5000	nF